Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2	("6747282").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/13 10:02
S1	0	355/72/$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 09:34
S2	1135	355/72.ccls.	US-PGPUB; USPAT	OR	ON	2006/01/12 09:35
S3	1	(((electro$5 near stat$3) or (vaccuum or vacuum)) near chuck) with ((transparent or clear) near layer)	US-PGPUB; USPAT	OR	ON	2006/01/12 09:36
S4	1	(((electro$4 near stat$3) or (vaccuum or vacuum)) near chuck) with ((transparent or clear) near layer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 09:38
S5	0	((electrost$3) near chuck) with ((transparent or clear) near layer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 09:39
S6	0	((electrost$3) near chuck) and ((transparent or clear) near layer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 09:39
S7	90	((electric$3) near (carrier or chuck)) and ((transparent or clear) near layer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 09:45
S8	0	S2 and S7	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 09:39

S9	7694	electrostatic adj chuck	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 09:40
S10	64	S2 and S9	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 09:41
S11	55543	(transparent or clear) near (bond or layer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 09:41
S12	0	S10 and S11	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 09:41
S13	230671	(conduct$4) near (bond or layer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 09:41
S14	4	S10 and S13	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 09:44
S15	325	355/23.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 09:44
S16	0	S15 and S10	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 09:44

S17	69	((electric$3) near (carrier or chuck)) and ((transparent or clear) near layer) and (wafer or substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 09:57
S18	666	361/234.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 09:56
S19	1558	((electrostat$3) near (carrier or chuck)) and (((transparent or clear) near layer) or glass) and (wafer or substrate) and ((conduct$4 adj layer) or (electrode))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 12:01
S20	39	S2 and S19	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 09:59
S21	35571	"355"/$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 10:05
S22	39	S21 and S20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 10:05
S23	64	S21 and S19	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 10:05
S24	25	S23 not S2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 10:08

S25	144151	430$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 10:08
S26	144151	"430"/$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 10:08
S27	70	S25 and S19	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 10:19
S28	637	361/234.ccls.	US-PGPUB; USPAT	OR	ON	2006/01/12 10:20
S29	1737459	(((transparent or clear) near layer) or glass)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 10:47
S30	2421220	S28 ad S29	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 10:47
S31	2319495	(transparent or clearor glass)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 10:48
S32	214	S28 and S31	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 11:35
S33	1556	430/138.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 11:36

S34	7979	430/5.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 11:36
S35	2414	430/30.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 11:36
S36	1654	430/20.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 11:36
S37	13130	S33 or S34 or S35 or S36	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 11:36
S38	18	S19 and S37	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 11:36
S39	2	("5777838").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/12 12:01
S40	1	S39 and (glass or clear or transparent)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 12:04
S41	2	("6122159").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/12 12:04

S42	1	S41 and (glass or clear or transparent)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 12:11
S43	3	("6166897").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/12 12:10
S44	0	S43 and ((glass or clear or transparent) same "22")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 12:11
S45	1	S43 and ((glass or clear or transparent))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 12:21
S46	7990	((glass or clear or transparent) adj layer) and ((conduct$4 or electrod$2) adj layer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 12:21
S47	3060	((glass or clear or transparent) adj layer) same((conduct$4 or electrod$2) adj layer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 12:22
S48	3060	((glass or clear or transparent) adj layer) same ((conduct$4 or electrod$2) adj layer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 12:22
S49	2146	((glass or clear or transparent) adj layer) same ((conduct$4 or electrod$2) adj layer) and (wafer or substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 12:22

S50	449	((glass or clear or transparent) adj layer) same ((conduct$4 or electrod$2) adj layer) and (wafer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 12:22
S51	5	((glass or clear or transparent) adj layer) same ((conduct$4 or electrod$2) adj layer) and (wafer) and (electrostatic adj chuck)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 14:34
S52	2	("5864459").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/12 14:34
S53	0	S52 and quartz	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 15:17
S54	1476	355/72.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 15:18
S55	177	S54 and quartz	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 15:47
S56	19	S54 and wafer same (electrostatic near chuck) samequartz	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 15:19
S57	0	S54 and wafer same (electrostatic near chuck) same quartz	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 15:19

S58	0	S54 and (wafer same (electrostatic near chuck) same quartz)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 15:19
S59	157	(wafer same (electrostatic near chuck) same quartz)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 15:45
S60	0	"20040012767" and quartz	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 15:34
S61	10	(("20050024809") or ("6351367") or ("6122159") or ("20020007911") or ("20020135967")).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/12 15:46
S62	1	S61 and quartz	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 16:05
S63	0	(double adj pattern) near (wafer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 16:05
S64	4	(multiple adj pattern) near (wafer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 16:24
S65	62332	(transparent or clear) adj (conductor or electrode)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 16:24

S66	3	S54 and S65	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 16:30
S67	666	361/234.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 16:30
S68	4	S67 and S65	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 16:47
S69	0	tape near ((wafer) with (electrostatic adj chuck))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 16:47
S70	5	tape near ((wafer with chuck))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/13 10:02